<table>
<thead>
<tr>
<th>ALL ASYMMETRY VIEWED FROM TOP SIDE</th>
<th>BOARD 41: U-00-01140</th>
<th>RES 11</th>
<th>SEM RESE Res In VericoreControl</th>
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<tr>
<td>LAYER NAME: Signal Layer 1</td>
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<td>GENERATED: 2-29-2017 1:31:26 PM</td>
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<td>TEXAS INSTRUMENTS</td>
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